

## Power line chokes

Ring core chokes with iron powder core  
250 V AC, 0.3 ... 3 A, 0.033 ... 1.2 mH, +60 °C

**Series/Type:**            **B82623**

**Date:**                    May 2025

## Power line chokes

B82623

### Ring core chokes with iron powder core

**Rated voltage 250 V AC/350 V DC**

**Rated current 0.3 ... 3 A**




**Nominal inductance 0.033 ... 1.2 mH**

#### Construction

- Ring core double choke
- Iron powder core with epoxy coating
- Polycarbonate case (UL 94 V-0)
- Polyurethane potting (UL 94 V-0)
- Sector winding
- Color of materials may vary



#### Features

- Effective suppression of differential-mode interferences at higher frequencies
- Moderate inductance decrease at current load
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2) and UL 1283
- UL and ENEC (VDE) approvals   
- RoHS-compatible

#### Applications

- Suppression of differential-mode interferences
- Compact switch-mode applications
- Reduction of harmonics and PFC

#### Terminals

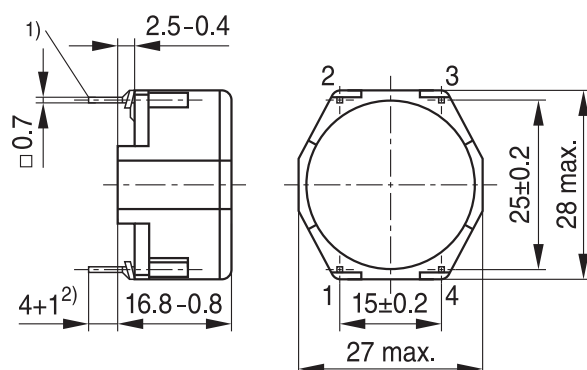
- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Pins 0.7 × 0.7 (mm)
- Lead spacing 15 × 25 (mm)

#### Marking

Product brand, approval signs and VDE standard number, ordering code, graphic symbol, rated current, nominal inductance, rated voltage, "GKC" date of manufacture (MMYY.optional internal ID code)

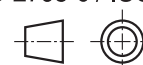
#### Delivery mode

- Blister tray in cardboard box

**Dimensional drawing and pin configuration**


No polarity  
IND2408-N-E

Part tolerances to ISO 2768-c / ISO 8015.  
Size ISO 14405 (E)  
All dimensions in mm



IND2140-B-E

<sup>1)</sup> Tin tips permissible



<sup>2)</sup> Dimension does not include tin tip

IND2432-8-E

**Technical data and measuring conditions**

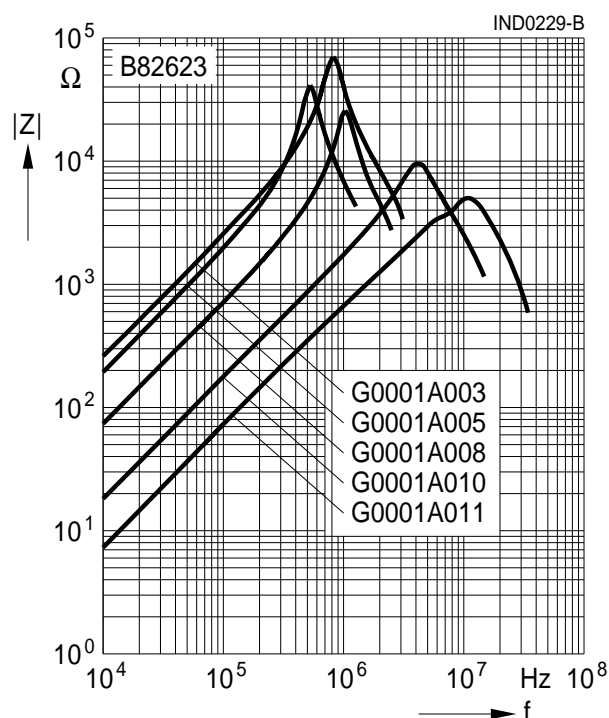
Rated voltage $V_R$	250 V AC (50/60 Hz) / 350 V DC
Test voltage $V_{test}$	1500 V AC, 2 s (winding/winding)
Rated temperature $T_R$	+60 °C
Rated current $I_R$	Referred to 50 Hz and rated temperature
Nominal inductance $L_N$	Defined at zero DC current bias Measured with Agilent 4284A at 0.1 mA, +20 °C Measuring frequency: $L_N \leq 1 \text{ mH} = 100 \text{ kHz}$ $L_N > 1 \text{ mH} = 10 \text{ kHz}$ Inductance is specified per winding.
Inductance tolerance	±20% at +20 °C
Inductance at rated current	Measured at DC magnetic bias with $I_R$ with Agilent 4284A at 0.1 mA, +20 °C, typical values Measuring frequency: $L_N \leq 1 \text{ mH} = 100 \text{ kHz}$ $L_N > 1 \text{ mH} = 10 \text{ kHz}$
DC resistance $R_{typ}$	Measured at +20 °C, typical values, specified per winding
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 ±5) °C, (3 ±0.3) s Wetting of soldering area ≥ 95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions (packaged)	−25 °C ... +40 °C, ≤ 75% RH
Weight	Approx. 20 g
Approvals	EN 60938-2, UL 1283

**Power line chokes**
**B82623**
**Ring core chokes with iron powder core**
**Characteristics and ordering codes**

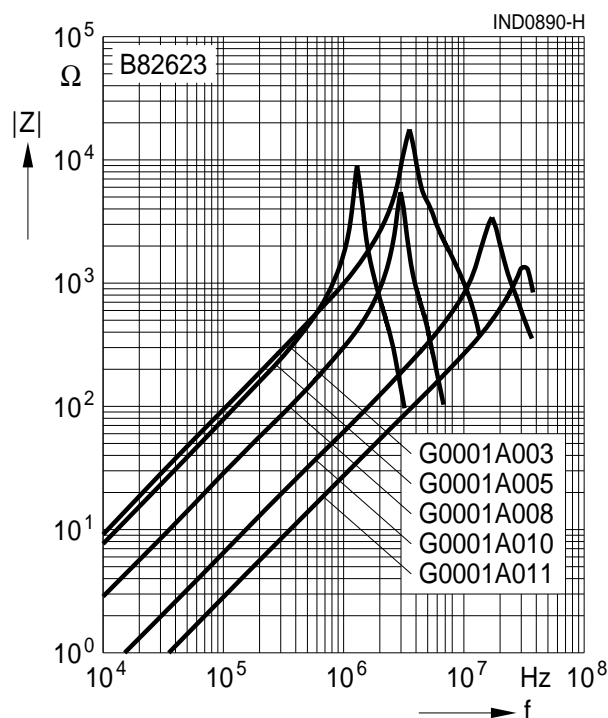
$I_R$ A	$L_N$ mH	L at $I_R$ , typ. mH	$R_{typ}$ $\Omega$	Ordering code	Approvals	
						
0.3	1.2	1.05	1.9	B82623G0001A003	×	×
0.5	1.0	0.75	1.1	B82623G0001A005	×	×
1	0.33	0.25	0.4	B82623G0001A008	×	×
2	0.082	0.062	0.1	B82623G0001A010	×	×
3	0.033	0.025	0.045	B82623G0001A011	×	×

× = approval granted

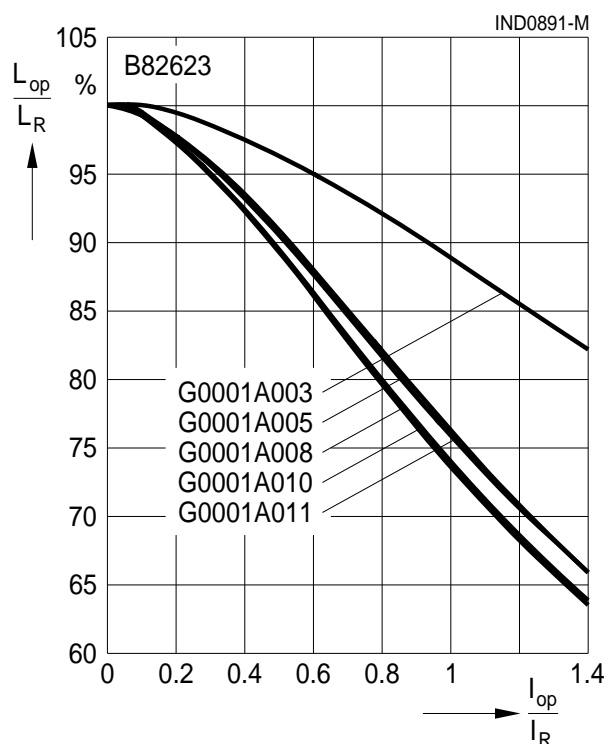
**Impedance  $|Z|$  versus frequency  $f$**   
**(differential-mode)** measured with windings  
in series at +20 °C, typical values



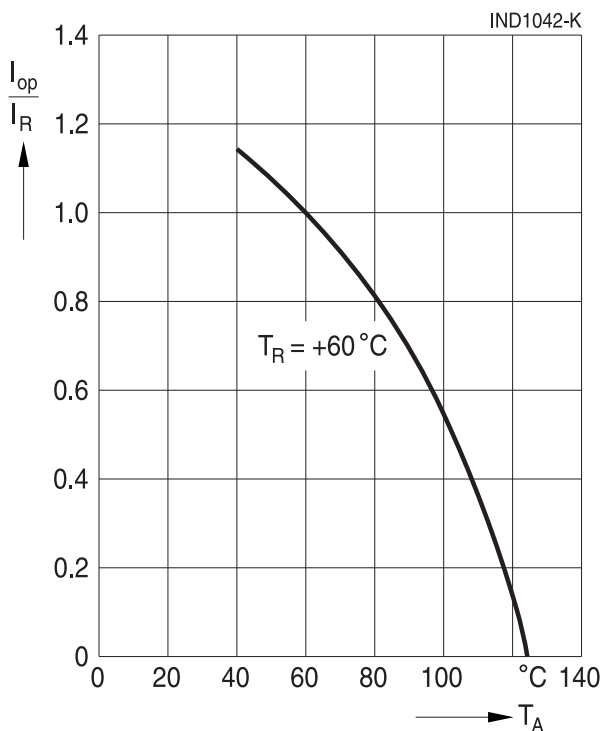
**Impedance  $|Z|$  versus frequency  $f$**   
**(common-mode)** measured with windings  
in parallel at +20 °C, typical values



**Relative inductance  $L_{op}/L_R$**   
**versus relative current  $I_{op}/I_R$**   
measured at +20 °C, typical values



**Current derating  $I_{op}/I_R$**   
**versus ambient temperature  $T_A$**



## Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
  - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
  - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.  
 Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
  - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
  - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
  - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
  - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
  - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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## Cautions and warnings

### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under [www.tdk-electronics.tdk.com/orderingcodes](http://www.tdk-electronics.tdk.com/orderingcodes).

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The following applies to all products named in this publication:

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2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
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## Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard.**  
The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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